RoHS

MS5536C

SMD Gage Pressure Module

SPECIFICATIONS

- **Pressure range -400 to 1000 mbar (Optional -1000 to 400 mbar)**
- **0.1 mbar Resolution**
- **Factory Calibrated (coefficients for software compensation store on-chip)**
- **3-wire serial interface**
- **Low voltage / low power**

MS5536C is a family of high-resolution factory calibrated pressure sensors. The devices include a piezoresistive pressure sensor and an ADC-Interface IC. The 3-wire serial interface ensures simple communication with any microcontroller. The devices provide digital pressure and temperature information as 16-Bit data word each. In addition 64-Bit of individually calibrated compensation coefficients are stored allowing for a highly accurate software compensation of process spread and temperature effects.
The devices have a very low standby current and automatically enter power down mode after each conversion. The optimum compromise of refresh rate and average current consumption can be defined by the application software.

FEATURES

- 16-Bit ADC Resolution
- Supply voltage 2.2 V to 3.6 V
- Low supply current
- -40°C to +85°C
- Small size
- No external components required

APPLICATIONS

- Medical application
- Blood pressure meter
- Air flow measurement
- HVAC application

BLOCK DIAGRAM

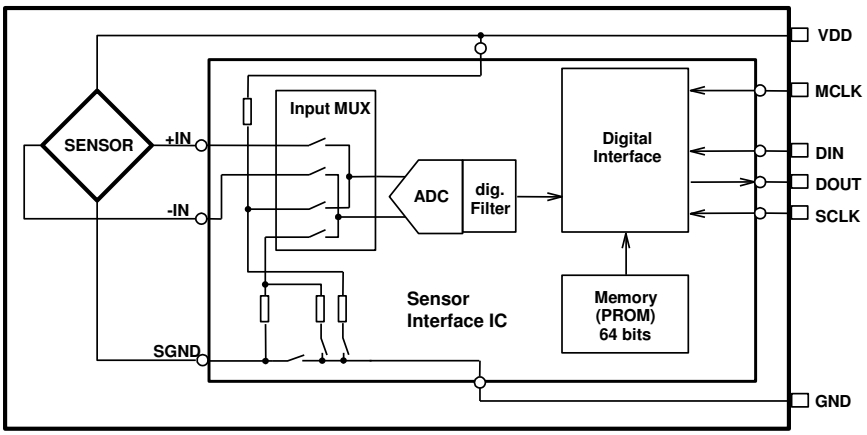


Fig. 1: Block diagram MS5536C

PIN CONFIGURATION

Fig. 2: Pin configuration of MS5536-CPJU, MS5536-CNJU

PIN DESCRIPTION

Pin Name	Pin	Type	Function
N/C	1		Not Connected
VDD	2	P	Positive Supply Voltage
MCLK	3	I	Master Clock (32.768kHz)
DIN	4	I	Data Input
DOUT	5	O	Data Output
SCLK	6	I	Serial Data Clock
GND	7	G	Ground
N/C	8		Not Connected
N/C	9		Not Connected
N/C	10		Not Connected
N/C	11		Not Connected
N/C	12		Not Connected
PV	13	N	Negative Programming Voltage
PEN	14	I	Programming Enable

NOTE

Pins 13 (PEN) and 14 (PV) are only used by the manufacturer for calibration purposes and should not be connected.

PRESSURE UNIT CONVERSION

mbar	kPa	bar	mm Hg	PSI	atm	mm H_2O	Inches H_2O
400.0	40.00	0.4000	300.0	5.801	0.3947	4079	160.57
1000.0	100.00	1.0000	750.0	14.503	0.9869	10198	401.45

ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Conditions	Min	Max	Unit	Notes
Supply voltage	V_{DD}		-0.3	4	V	
Differential Overpressure	P_{diff}		-5	5	bar	1, 2
CM Overpressure	P_{CM}			10	bar	1, 3
Storage temperature	T_S		-40	+125	°C	1

NOTES

1) Storage and operation in an environment of dry and non-corrosive gases.
2) For a differential sensor, Differential Pressure is the difference of pressure at port 1 minus pressure at port 2. For a gage sensor Differential Pressure is the difference of pressure at the port minus pressure of the ambient air.
3) For a differential sensor Common Mode Pressure is the average of the pressure at port 1 and port 2. For a gage sensor Common Mode Pressure is the average of the pressure at the port and the pressure of the ambient air.

RECOMMENDED OPERATING CONDITIONS

(T_a = 25 °C, V_{DD} = 3.0 V unless noted otherwise)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Supply voltage	V_{DD}		2.2	3.0	3.6	V
Supply current, average (1) during conversion (2) standby (no conversion)	 I_{avg} I_{sc} I_{ss}	V_{DD} = 3.0 V		 4 1	 0.1	 µA mA µA
Current consumption into MCLK (3)		MCLK = 32.768 kHz			0.5	µA
Operating pressure range (4)	p	Pressure Range P devices	-400		1000	mbar
Operating pressure range (4)	p	Pressure Range N devices	-1000		400	mbar
Operating temperature range	T_a		-40	+25	+85	°C
Conversion time	t_{conv}	MCLK = 32.768 kHz			35	ms
External clock signal (5)	MCLK		30.000	32.768	35.000	kHz
Duty cycle of MCLK			40/60	50/50	60/40	%
Serial data clock	SCLK				500	kHz

NOTES

1) Under the assumption of one conversion every second. Conversion means either a pressure or a temperature measurement started by a command to the serial interface of MS5536C.
2) During conversion the sensor will be switched on and off in order to reduce power consumption; the total on time within a conversion is about 2 ms. The current specified is active only during this time.
3) This value can be reduced by switching off MCLK while MS5536C is in standby mode.
4) Positive pressure corresponds to higher pressure at port 1 (nozzle port on plastic cap).
5) It is strongly recommended that a crystal oscillator be used because the device is sensitive to clock jitter. A square-wave form of the clock signal is a must.

ELECTRICAL CHARACTERISTICS

DIGITAL INPUTS

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Input High Voltage	V_{IH}		80% V_{DD}		100% V_{DD}	V
Input Low Voltage	V_{IL}		0% V_{DD}		20% V_{DD}	V
Signal Rise Time	t_r			200		ns
Signal Fall Time	t_f			200		ns

DIGITAL OUTPUTS

(T = -40 °C .. 85 °C V_{DD} = 2.2 V .. 3.6 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Output High Voltage	V_{OH}	I_{source} = 0.6 mA	80% V_{DD}		100% V_{DD}	V
Output Low Voltage	V_{OL}	I_{sink} = 0.6 mA	0% V_{DD}		20% V_{DD}	V
Signal Rise Time	t_r			200		ns
Signal Fall Time	t_f			200		ns

AD-CONVERTER

(T = -40 °C .. 85 °C V_{DD} = 2.2 V .. 3.6 V)

Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Resolution				16		Bit
Linear Range			4'000		40'000	LSB
Conversion Time		MCLK = 32.768 kHz			35	ms
INL		Within linear range	-5		+5	LSB

PRESSURE OUTPUT CHARACTERISTICS

With the calibration data stored in the interface IC of the MS5536C, the following characteristics can be achieved:

(V_{DD} = 3.0 V unless noted otherwise)

Parameter	Conditions	Min	Typ	Max	Unit	Notes
Resolution			0.1		mbar	1
Pressure Accuracy	T_a = 10 .. +40°C MS5536-CPJU: p = -100 .. 700 mbar MS5536-CNJU: p = -700 .. 100 mbar	-2.5		+2.5	mbar	2
	T_a = 10 .. +40°C MS5536-CPJU: p = -400 .. 1000 mbar MS5536-CNJU: p = -1000 .. 400 mbar	-9		+9	mbar	2
Maximum Error over Temperature	T_a = -40 .. +85°C p = const.	-7		+3	mbar	3
Maximum Error over Supply Voltage	V_{DD} = 2.2 .. 3.6 V	-1.5	0	1.5	mbar	2

NOTES

1) A stable pressure reading of the given resolution requires taking the average of 2 to 8 subsequent pressure values due to noise of the ADC.
2) Specified values assume an offset adjustment at any given pressure e.g. p = 0 prior to the measurement.
3) Specified values assume quadratic temperature compensation (Refer to the paragraph "second-order temperature compensation" in the section "FUNCTION").

TEMPERATURE OUTPUT CHARACTERISTICS

The temperature information is not required for most applications, but it is necessary to allow for temperature compensation of the output. Reference temperature is 20 °C.

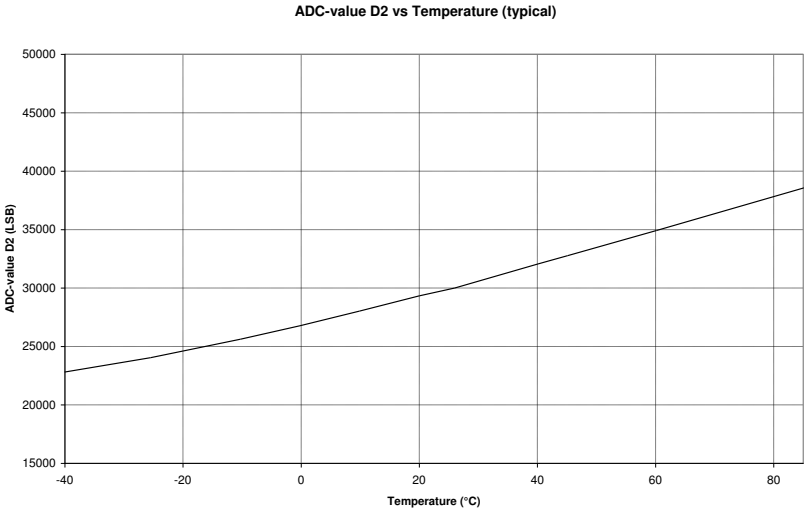
(V_{DD} = 3.0 V unless noted otherwise)

Parameter	Conditions	Min	Typ	Max	Unit	Notes
Resolution			0.01		°C	
Accuracy	at reference temperature	-0.8		0.8	°C	1, 2
	T_a = 10 .. +40°C	-1.5		1.5	°C	1, 2
	T_a = -40 .. +85°C	-1.5		3	°C	1, 2
Maximum Error over Supply Voltage	V_{DD} = 2.2 .. 3.6 V	-0.2		0.2	°C	2

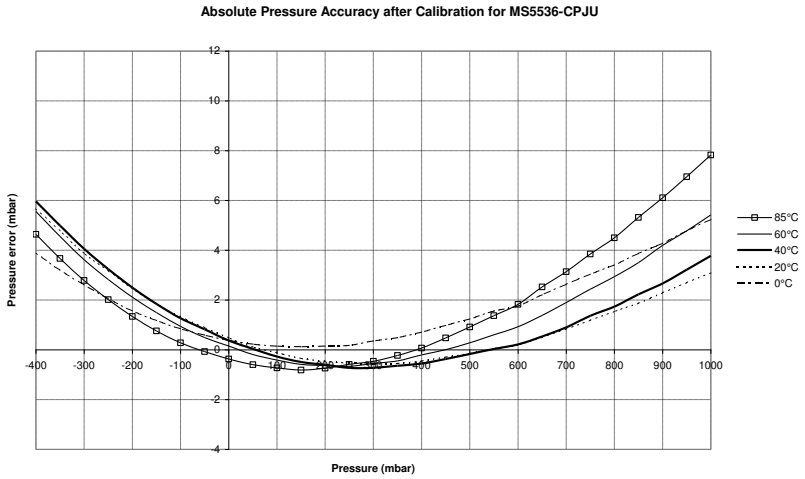
NOTES

1) Refer to the paragraph second-order temperature compensation in the section "FUNCTION".
2) ⇆p=0

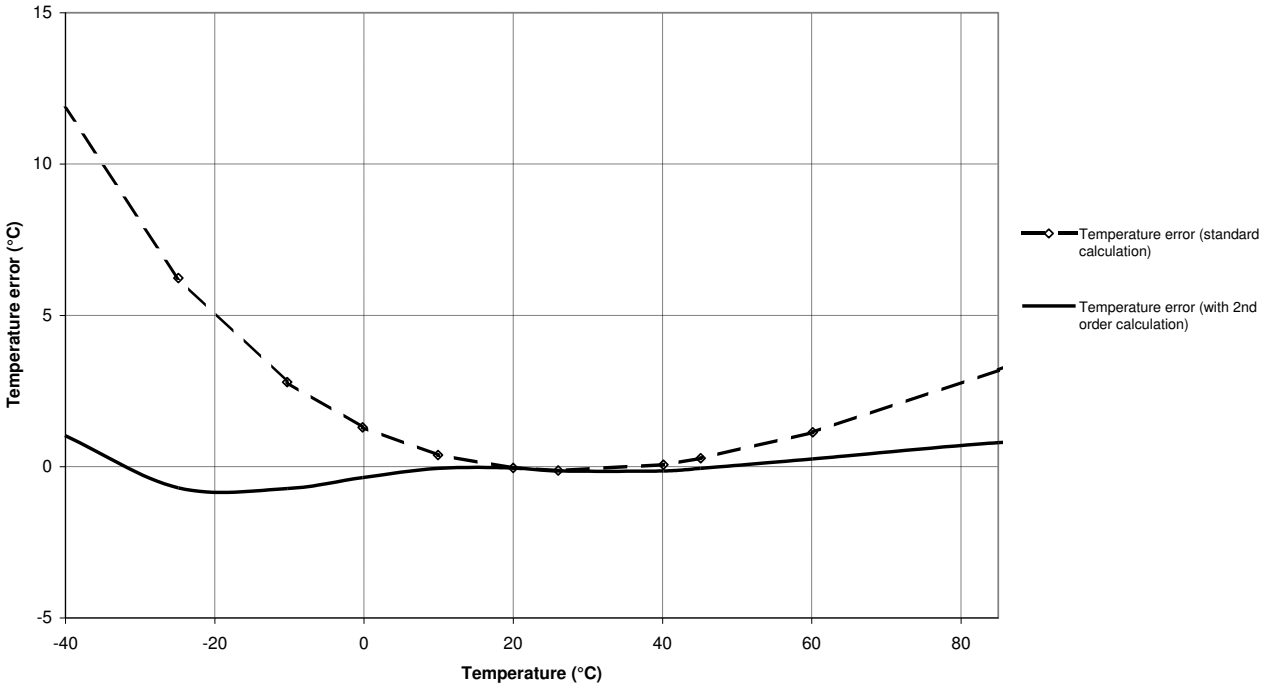
TYPICAL PERFORMANCE CURVES



S



Temperature Error Accuracy vs temperature (typical)



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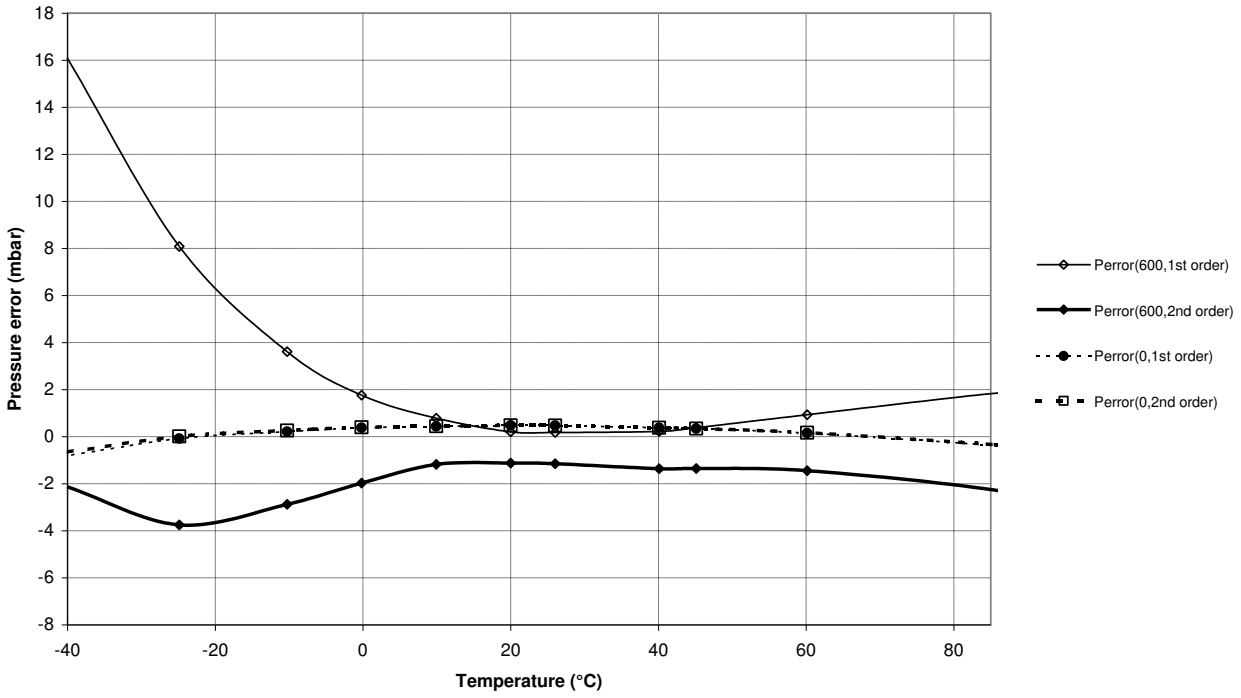
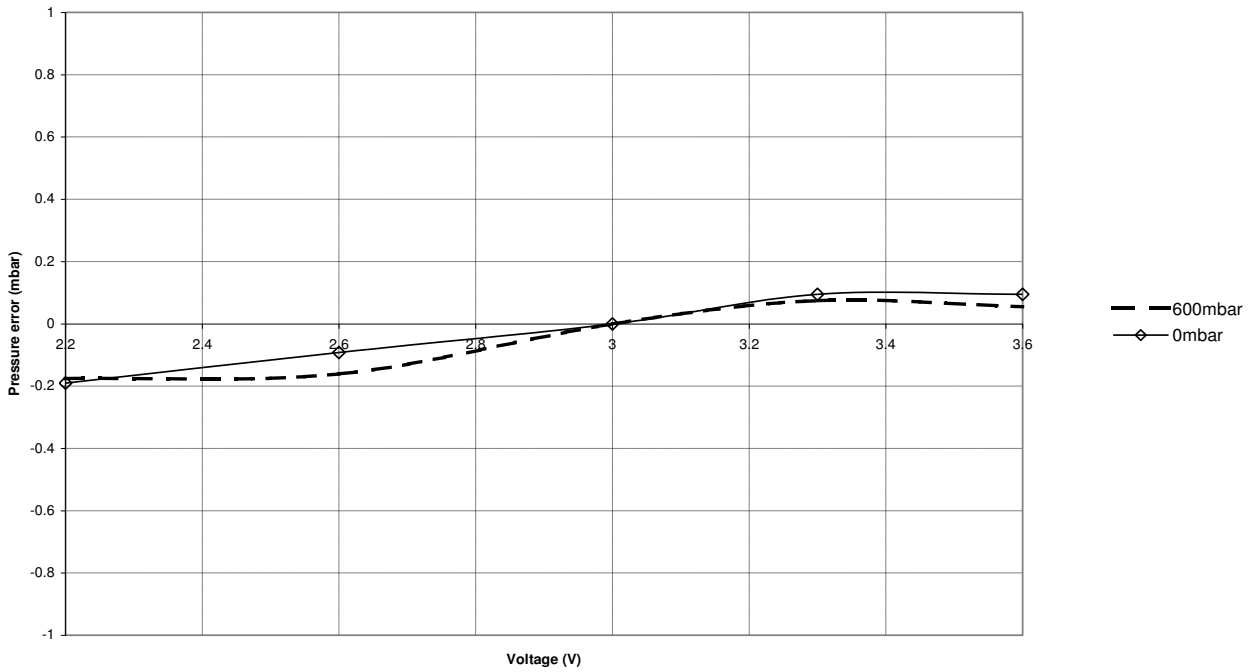
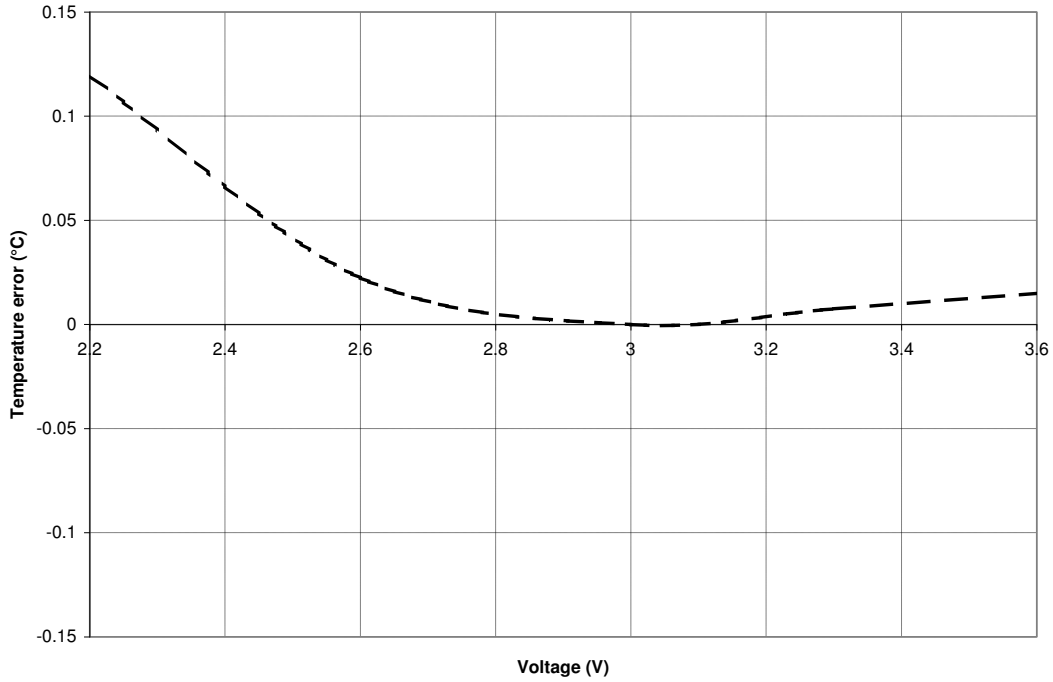
Pressure Error Accuracy vs temperature (typical) for MS5536-CPJU



Pressure error vs supply voltage (typical)



Temperature error vs supply voltage (typical)



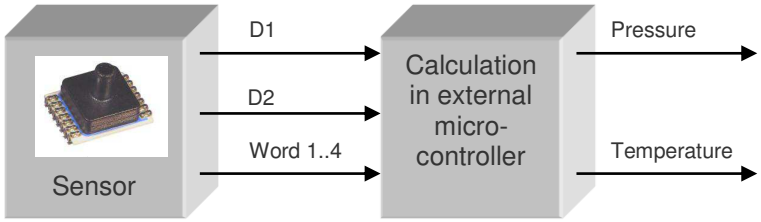
FUNCTION

GENERAL

The MS5536C consists of a piezo-resistive sensor and a sensor interface IC. The main function of the MS5536C is to convert the uncompensated analogue output voltage from the piezo-resistive pressure sensor to a 16-bit digital value, as well as providing a 16-bit digital value for the temperature of the sensor.

Measured pressure (16-bit)	"D1"
Measured temperature (16-bit)	"D2"

As the output voltage of a pressure sensor is strongly dependent on temperature and process tolerances, it is necessary to compensate for these effects. This compensation procedure must be performed by software using an external microcontroller.



For both pressure and temperature measurement the same ADC is used (sigma delta converter):

- for the pressure measurement, the differential output voltage from the pressure sensor is converted
- for the temperature measurement, the sensor bridge resistor is sensed and converted

During both measurements the sensor will only be switched on for a very short time in order to reduce power consumption. As both, the bridge bias and the reference voltage for the ADC are derived from V_{DD}, the digital output data is independent of the supply voltage.

FACTORY CALIBRATION

Every module is individually factory calibrated at two temperatures and two pressures. As a result, 6 coefficients necessary to compensate for process variations and temperature variations are calculated and stored in the 64-bit PROM of each module. These 64-bit (partitioned into four words of 16-bit) must be read by the microcontroller software and used in the program converting D1 and D2 into compensated pressure and temperature values.

PRESSURE AND TEMPERATURE MEASUREMENT

The sequence of reading pressure and temperature as well as of performing the software compensation is depicted in flow chart, Fig. 3 and Fig. 5.

First WORD1 to WORD4 are read through the serial interface. This can be done once after reset of the microcontroller that interfaces to the MS5536C. Next the compensation coefficients C1 to C6 are extracted using Bit-wise logical- and shift-operations (refer to Fig. 4 for the Bit-pattern of word 1 to word 4).
For the pressure measurement, the microcontroller has to read the 16-Bit values for pressure (D1) and temperature (D2) via the serial interface in a loop (for instance once every second). Then, the compensated pressure is calculated out of D1, D2 and C1 to C6 according to the algorithm in Fig. 3 (possibly using quadratic temperature compensation according to Fig. 5). All calculations can be performed with signed 16-Bit variables. Results of multiplications may be up to 32-Bit long (+sign). In the flow according to Fig. 3 each multiplication is followed by a division. This division can be performed by Bit-wise shifting (divisors are to the power of 2). It is ensured that the results of these divisions are less than 65536 (16-Bit).

For the timing of signals to read out WORD1 to WORD4, D1, and D2 please refer to the paragraph ‘Serial Interface’.

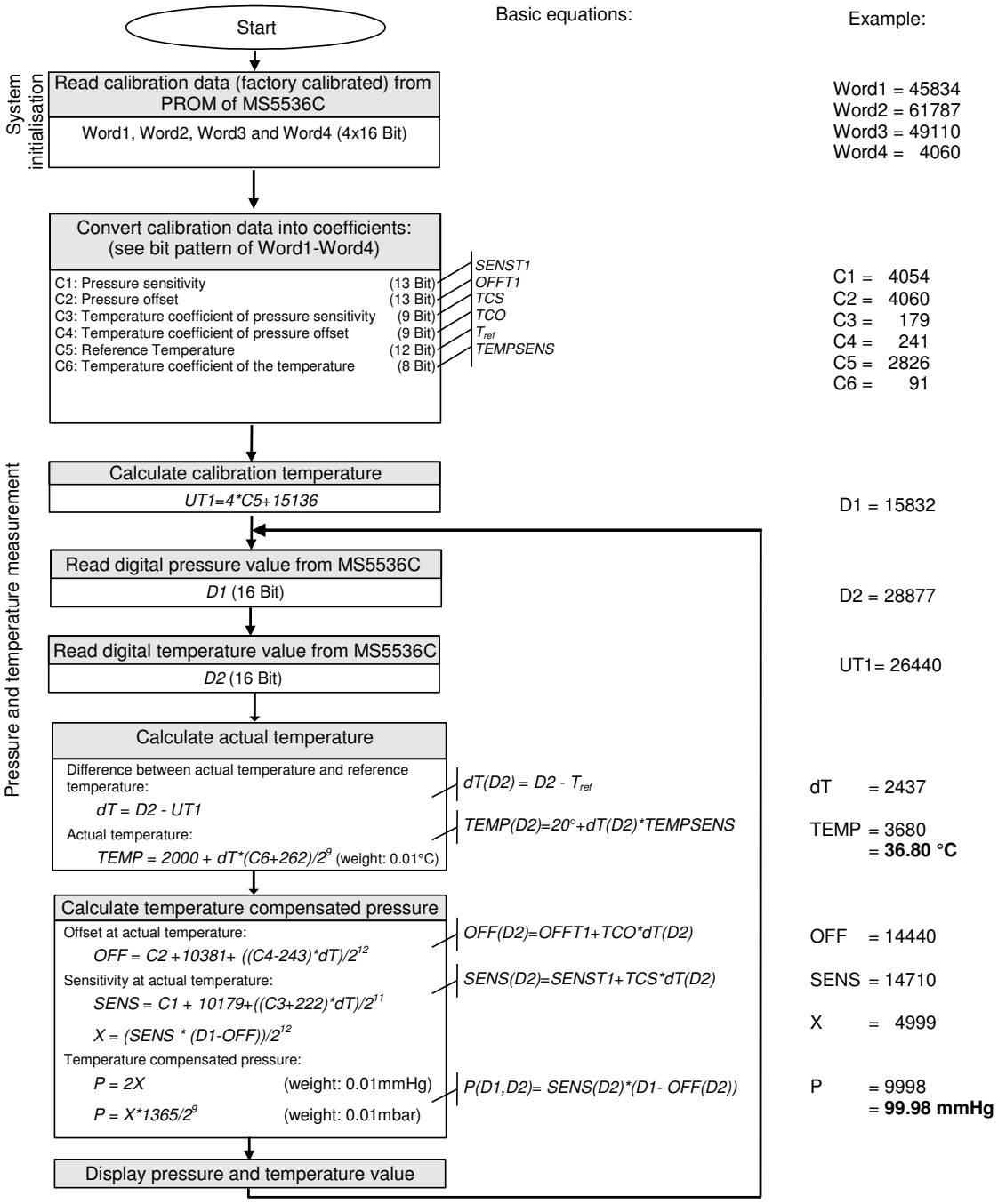


Fig. 3: Flow chart for pressure and temperature reading and software compensation

NOTES

1) Readings of D2 can be done less frequently, but the display will be less stable in this case
2) For a stable display of 0.1 mm Hg resolution or below, it is recommended to display the average of at least 8 subsequent pressure values.

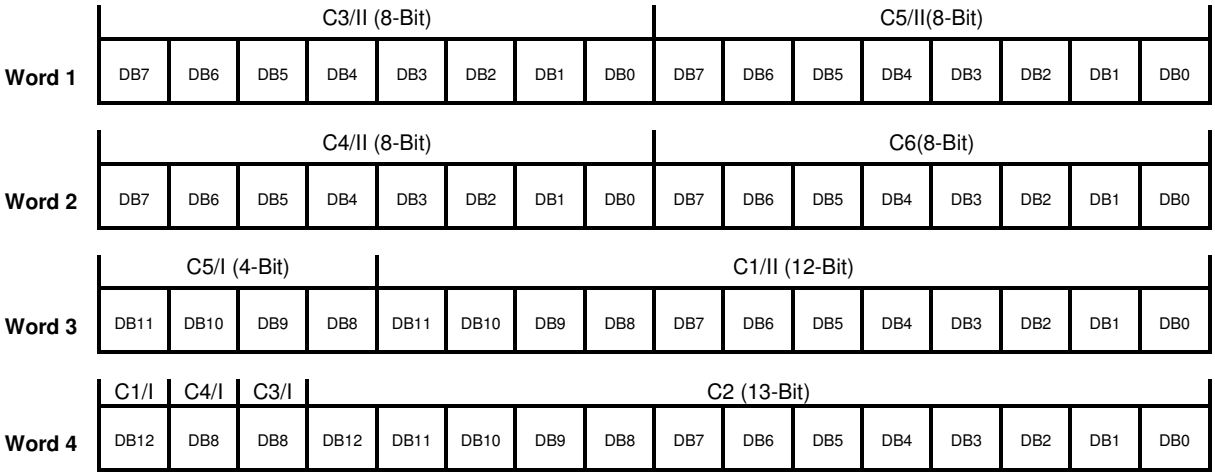


Fig. 4: Arrangement (Bit-pattern) of calibration data in Word1 to Word4

SECOND-ORDER TEMPERATURE COMPENSATION

In order to obtain full accuracy over the whole temperature range, it is recommended to compensate for the non-linearity of the output of the temperature sensor. This can be achieved by the second-order temperature calculation, i.e. by replacing the block 'Calculate actual temperature' in flow chart Fig. 3 by the following sequence:

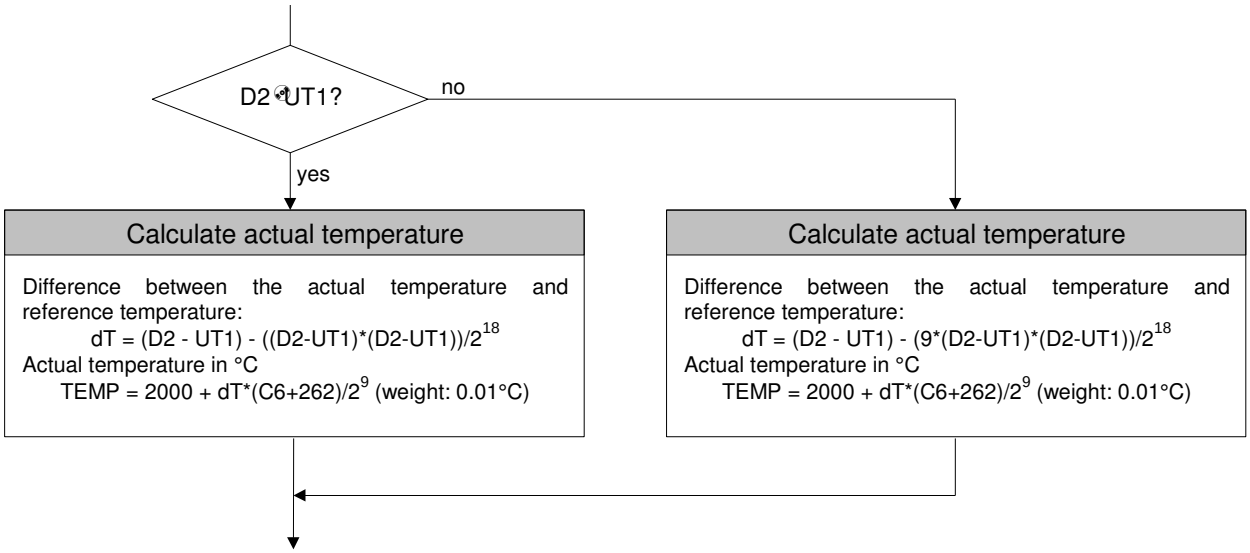


Fig. 5: Flow chart for calculating the temperature to the optimum accuracy. The value for *dT* thus obtained is then used for the calculation of the temperature compensated pressure as shown in Fig. 3.

SERIAL INTERFACE

The MS5536C communicates with microprocessors and other digital systems via a 3-wire synchronous serial interface as shown in Fig. 1. The SCLK (Serial Clock) signal initiates the communication and synchronizes the data transfer with each Bit being sampled by the MS5536C on the rising edge of SCLK and each Bit being sent by the MS5536C on the rising edge of SCLK. The data should thus be sampled by the microcontroller on the falling edge of SCLK and sent to the MS5536C with the falling edge of SCLK. The SCLK-signal is generated by the microprocessor's system. The digital data provided by the MS5536C on the DOUT pin is either the conversion result or the software calibration data. In addition the signal DOUT (Data Out) is also used to indicate the conversion status (conversion-ready signal, see below). The selection of the output data is done by sending the corresponding instruction on the pin DIN (Data Input).

Following is a list of possible output data instructions:

•	Conversion start for pressure measurement and ADC-data-out	"D1"	(Figure 6a)
•	Conversion start for temperature measurement and ADC-data-out	"D2"	(Figure 6b)
•	Calibration data read-out sequence for word 1 and word 3		(Figure 6c)
•	Calibration data read-out sequence for word 2 and word 4		(Figure 6d)
•	RESET sequence		(Figure 6e)

Every communication starts with an instruction sequence at Pin DIN. Fig. 6 shows the timing diagrams for the MS5536C. The device does not need a 'Chip select' signal. Instead there is a Start Sequence (3-Bit high) before each Setup Sequence and Stop Sequence (3-Bit low) after each Setup Sequence. The Setup Sequence consists in 4-Bit that select a reading of pressure, temperature or calibration data. In case of pressure- (D1) or temperature- (D2) reading the module acknowledges the start of a conversion by a low to high transition at Pin DOUT during the last Bit of the Stop Sequence.
Two additional clocks at SCLK are required after the acknowledge signal. Then SCLK is to be held low by the microcontroller until a high to low transition on DOUT indicates the end of the conversion.
This signal can be used to create an interrupt in the microcontroller. The microcontroller may now read out the 16-Bit word by giving another 17 clocks on the SLCK pin. It is possible to interrupt the data read-out sequence with a hold of the SCLK signal. **It is important to always read out the last conversion result before starting a new conversion.**

The RESET-sequence is special as its unique pattern is recognized by the module in any state. By consequence it can be used to restart if synchronization between the microcontroller and the MS5536C has been lost. This sequence is 21-Bit long. The DOUT signal might change during that sequence (see Fig. 6e). It is recommended to send the RESET sequence before first conversion sequence to avoid hanging up the protocol permanently in case of electrical interference.

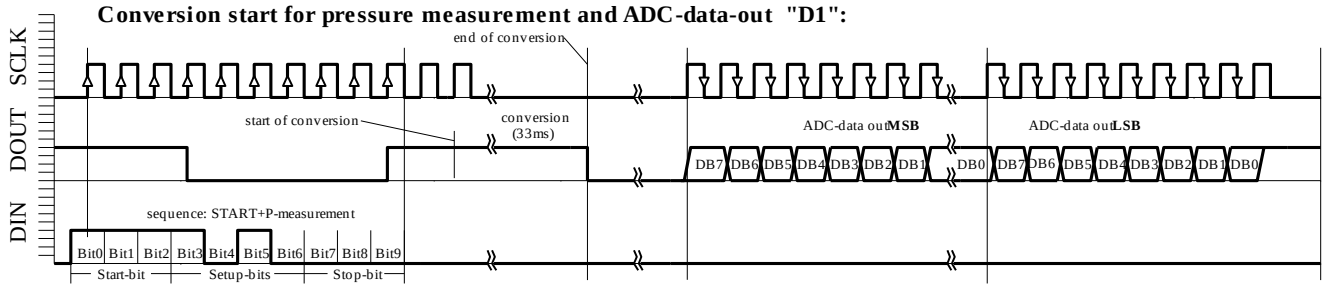


Fig. 6a: D1 ACQUISITION sequence

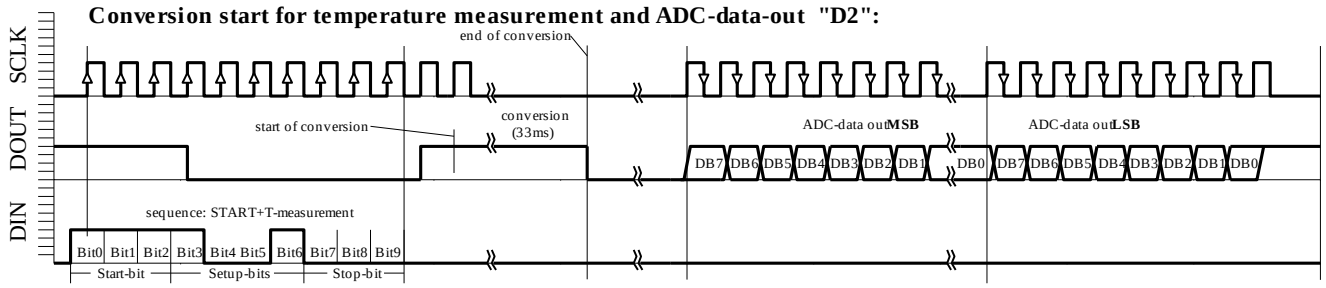


Fig. 6b: D2 ACQUISITION sequence

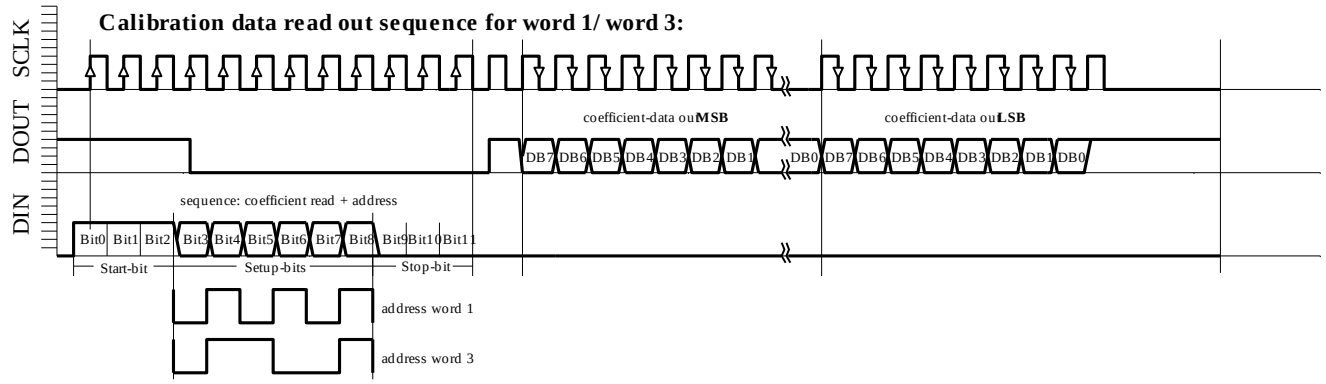


Fig. 6c: Word1, Word3 READING sequence

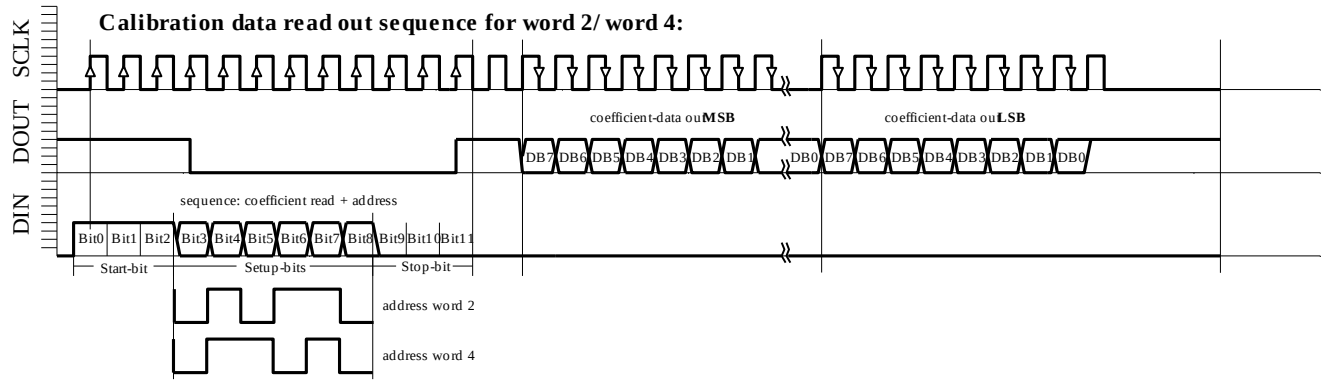


Fig. 6d: W2, W4 READING sequence

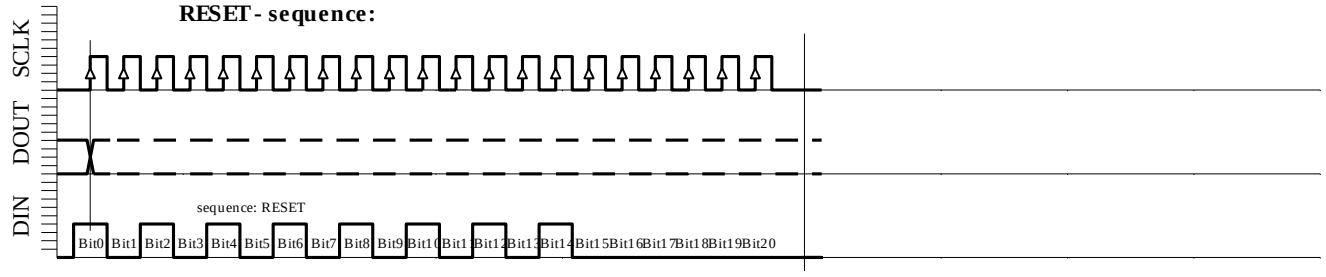


Fig. 6e: RESET sequence (21 bit)

APPLICATION INFORMATION

GENERAL

The MS5536C consists in a sensor die and a mixed signal interface IC on a single ceramic substrate with Pb-free leads attached. It is compatible with standard PCB-assembly technologies (Pick and Place followed by IR-reflow soldering). Single sided PCB layout is possible. The device directly interfaces to a standard microcontroller, no costly external components like Instrumentation Amplifiers or A/D converters are required. A mark on the ceramic substrate indicates pin 1 (see Fig. 2).
The silicon pressure transducer, the IC and the bonding wires are protected against humidity by a silicone gel and against mechanical damage by a plastic cap. The cap is also used as the pressure port. The MS5536C does not show pressure hysteresis effects.
The simple digital 3 wire synchronous serial interface eliminates all sensitive analogue signal lines on the PCB with their often critical routing and guarding issues. The protocol does not require specific interface cells and can be implemented on any microcontroller using standard I/Os. The required external clock-signal of 32.768 kHz is standard in the watch industry and readily available in most hand-held applications.
The MS5536C is well suited for battery powered portable devices. This is due to the low supply voltage of 2.2V and the small amount of computing power required to calculate the compensated values for pressure and temperature (use of 4-Bit microcontrollers is possible). No costly end-of-line calibrations are required as the MS5536C contains factory stored calibration coefficients.
In order to further enhance accuracy it is recommended to periodically recalibrate the device offset in the application software. This can be achieved by reading the compensated pressure in a known state, preferably at p=0 (e.g. Blood Pressure Meters with vent open). The detected difference between displayed and actual pressure can be memorized and subtracted from following readings.
The pressure range and port configurations make the MS5536C well suited for applications like blood-pressure metering, air flow and pressure measurements in HVAC-systems and liquid level detection.

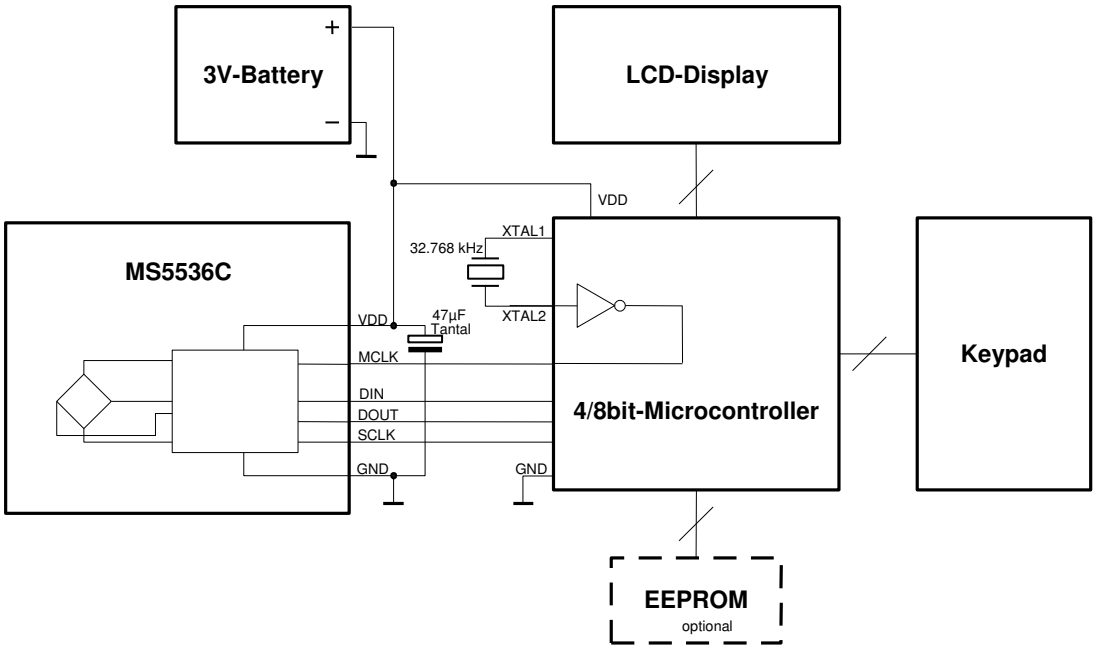
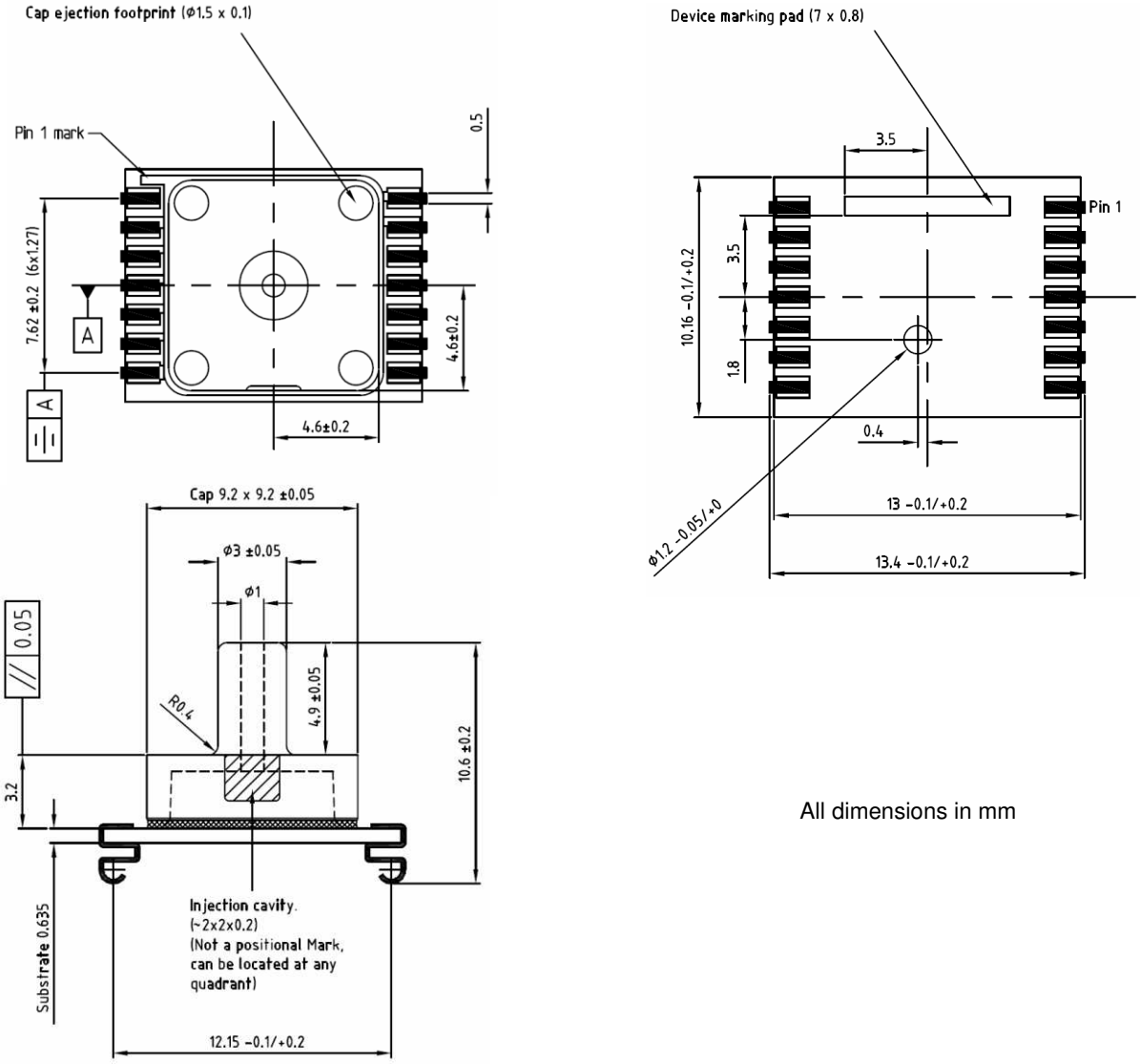


Fig. 7: Application example of the MS5536C for a battery powered device

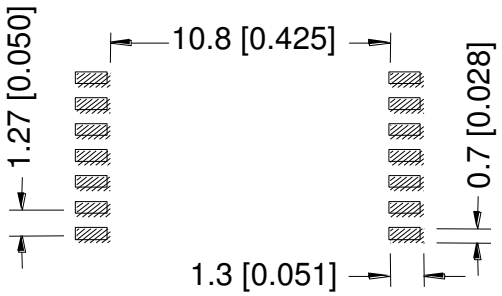
DEVICE PACKAGE OUTLINES



All dimensions in mm

Fig. 8: Device package outlines of MS5536-CPJU / MS5536-CNJU

PAD LAYOUT FOR MS5536-C



All dimensions in mm [inch]

Fig. 9: Recommended pad-layout for MS5536-CPJU / MS5536-CNJU

ASSEMBLY

DECOUPLING CAPACITOR

Particular care must be taken when connecting the device to power supply. A 47 µF tantalum capacitor must be placed as close as possible of the MS5536C's VDD pin. This capacitor will stabilise the power supply during data conversion and thus, provide the highest possible accuracy.

SOLDERING

Please refer to the application note AN808 for all soldering issues.

MOUNTING

The MS5536C can be placed with automatic Pick&Place equipment using a special vacuum nozzle. It will not be damaged by the vacuum.

For a good mechanical stability, it is important to solder all contact pads. The Pins PEN and PV must be left open or connected to Vdd. **Do not connect to GND!**

LIGHT SENSITIVITY

The MS5536C is protected against sunlight by the cap on front side. It is, however, important to note that the sensor may still be slightly sensitive to sunlight, especially to infrared light sources (Light may also enter the negative pressure port on backside). This is due to the strong photo effect of silicon. As the effect is reversible there will be no damage, but the user has to take care that in the final product the sensor cannot be exposed to direct light during operation. This can be achieved for instance by placing mechanical parts with holes in such that light cannot pass.

CONNECTING THE PRESSURE PORT

The best connection to the pressure port is achieved with a flexible tube fitted to the full length of the nozzle. Care should be taken to keep the nozzle clean. The tube should be flexible enough to minimize the mechanical stress on the module (see Fig. 10)

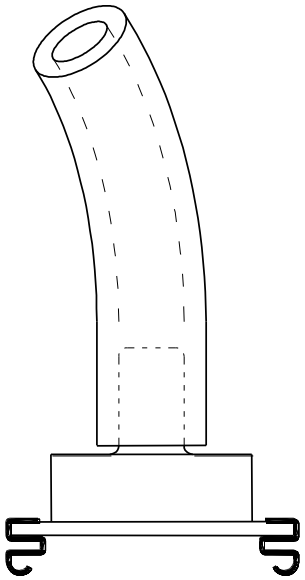


Fig. 10: Connection to pressure port

CLEANING

The MS5536C has been manufactured under cleanroom conditions. It is therefore recommended to assemble the sensor under class 10'000 or better conditions. Should this not be possible, it is recommended to protect the sensor opening during assembly from entering particles and dust. To avoid cleaning of the PCB, solder paste of type 'No-Clean' shall be used.
CLEANING MIGHT DAMAGE THE SENSOR!

ESD PRECAUTIONS

The electrical contact pads are protected against ESD up to 4 kV HBM (human body model). It is therefore essential to ground machines and personal properly during assembly and handling of the device. The MS5536C is shipped in antistatic transport boxes. Any test adapters or production transport boxes used during the assembly of the sensor shall be of an equivalent antistatic material.

ORDERING INFORMATION

Product Code	Product	Art. No	Package	Comments
MS5536-CPJU	SMD Gage Pressure Module RoHS	325536008	Gage with plastic cap, upright nozzle, vent hole on backside, J-Lead type	Pressure Range (port1 – port2): -400 mbar …+1000 mbar
MS5536-CNJU	SMD Gage Pressure Module RoHS	325536009	Gage with plastic cap, upright nozzle, vent hole on backside, J-Lead type	Pressure Range (port1 – port2): -1000 mbar …+400 mbar

NORTH AMERICA
Measurement Specialties, Inc.,
a TE Connectivity company
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LifeElectronics
Живое партнерство

ООО «ЛайфЭлектроникс» **“LifeElectronics” LLC**

ИНН 7805602321 КПП 780501001 Р/С 40702810122510004610 ФАКБ "АБСОЛЮТ БАНК" (ЗАО) в г.Санкт-Петербурге К/С 30101810900000000703 БИК 044030703

Компания «Life Electronics» занимается поставками электронных компонентов импортного и отечественного производства от производителей и со складов крупных дистрибьюторов Европы, Америки и Азии.

С конца 2013 года компания активно расширяет линейку поставок компонентов по направлению коаксиальный кабель, кварцевые генераторы и конденсаторы (керамические, пленочные, электролитические), за счёт заключения дистрибьюторских договоров

Мы предлагаем:

- *Конкурентоспособные цены и скидки постоянным клиентам.*
- *Специальные условия для постоянных клиентов.*
- *Подбор аналогов.*
- *Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.*

- *Приемлемые сроки поставки, возможна ускоренная поставка.*
- *Доставку товара в любую точку России и стран СНГ.*
- *Комплексную поставку.*
- *Работу по проектам и поставку образцов.*
- *Формирование склада под заказчика.*

- *Сертификаты соответствия на поставляемую продукцию (по желанию клиента).*
- *Тестирование поставляемой продукции.*
- *Поставку компонентов, требующих военную и космическую приемку.*
- *Входной контроль качества.*
- *Наличие сертификата ISO.*

В составе нашей компании организован Конструкторский отдел, призванный помогать разработчикам, и инженерам.

Конструкторский отдел помогает осуществить:

- *Регистрацию проекта у производителя компонентов.*
- *Техническую поддержку проекта.*
- *Защиту от снятия компонента с производства.*
- *Оценку стоимости проекта по компонентам.*
- *Изготовление тестовой платы монтаж и пусконаладочные работы.*

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